506110047 06/16/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHAOLI LIU	09/10/2019
XINKAI SONG	09/20/2019
BINGRUI WANG	09/20/2019
YAO ZHANG	09/24/2019
SHUAI HU	09/20/2019

RECEIVING PARTY DATA

Name:	CAMBRICON TECHNOLOGIES CORPORATION LIMITED
Street Address:	NO.7 ZHICHUN ROAD, HAIDIAN DISTRICT
Internal Address:	FLOOR 11, BLOCK D, ZHIZHEN BUILDING
City:	BEIJING
State/Country:	CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16903304

CORRESPONDENCE DATA

Fax Number: (703)827-8128

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-995-9887
Email: uspto@bayes.law
Correspondent Name: BAYES PLLC

Address Line 1: 1765 GREENSBORO STATION PLACE

Address Line 2: SUITE 900

Address Line 4: MCLEAN, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	10015-01-0011-US
NAME OF SUBMITTER:	GANG (GAVIN) YE
SIGNATURE:	/Gang Ye/
DATE SIGNED:	06/16/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 15 source=10015-01-0011-US Declarations Assignment Signed#page1.tif source=10015-01-0011-US Declarations Assignment Signed#page2.tif source=10015-01-0011-US Declarations Assignment Signed#page3.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page4.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page5.tif source=10015-01-0011-US Declarations Assignment Signed#page6.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page7.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page8.tif source=10015-01-0011-US Declarations Assignment Signed#page9.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page10.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page11.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page12.tif source=10015-01-0011-US Declarations Assignment Signed#page13.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page14.tif source=10015-01-0011-US_Declarations_Assignment_Signed#page15.tif

DECLARATION

As the	below named inventor, I hereby declare that:
This d	eclaration is directed to:
\boxtimes	The attached application, or
	United States application or PCT international application number
	filed on

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) or equivalent and other good and valuable consideration paid to the below named inventor, the below named inventor, hereby sells and assigns to Cambricon Technologies Corporation Limited, a corporation formed under the laws of China, whose mailing address is Floor 11, Block D, Zhizhen Building, No 7 of Zhichun Road, Haidian District, Beijing, China (hereafter referred to as the Assignee), his/her entire right, title and interest, including the right to sue for past infringement and to collect for all past, present and future damages, for the United States of America (as defined in 35 U.S.C. § 100) and throughout the world,

- (a) in the invention(s) known as INTEGRATED CIRCUIT CHIP DEVICE for which application(s) for patent in the United States of America is identified above, in any and all applications thereon, in any and all Letters Patent(s) therefor, and
- (b) in any and all applications that claim the benefit of the patent application identified above in part (a), including non-provisional applications, continuing (continuation, divisional, or continuation-in-part) applications, reissues, extensions, renewals and reexaminations of the patent application or Letters Patent therefor listed above in part (a), to the full extent of the term or terms for which Letters Patents issue, and

all such rights, title and interest to be held and enjoyed by the above-named Assignee, its successors, legal representatives and assigns to the same extent as all such rights, title and interest would have been held and enjoyed by the Assignor had this assignment and sale not been made.

The below named inventor agrees to execute all papers necessary in connection with the application(s) and any non-provisional, continuing (continuation, divisional, or continuation-in-part), reissue, reexamination or corresponding application(s) thereof and also to execute separate assignments in connection with such application(s) as the Assignee may deem necessary or expedient.

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The below named inventor hereby represents that he/she has full right to convey the entire interest herein assigned, and that he/she has not executed, and will not execute, any agreement in conflict therewith.

EGAL N	AME OF INV	ENTOR				
JE (3) (E 1)		**************************************				
inventor:	Shaoli LIU	Shadi LiV	Date	9,10,W	1	
neremoe,	DHAUH LIEU	71031-11	Date.		<i></i>	

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IN his/her nar	WITNESS WHEREOF, one.	executed by the bel	low named inventor on	the date opposite
LEGAL N	AME OF INVENTOR			
Inventor:	Xinkai Song	Date:	20,9,2019	
Signature o	of Inventor: Xinka	ri Song		

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I his/her n	N WITNESS 'ame.	WHEREOF,	executed	by the	below	named	inventor	on the	date	opposite
LEGAL	NAME OF IN	VENTOR								
Inventor	: Bingrui W	'ang		Date:	: Militari di Militar	4.20	-2019			
Signatur	e of Inventor:	Birg	cui V	any					2020000000000	10000000000000000000000000000000000000

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IN WITNESS WHEREOF, executed by the below named inventor on the date opposite his/her name.

LEGAL NAME OF INVENTOR

Inventor: Yao Zhang Date: Supt 14th 2019
Signature of Inventor: Yao Zhang

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As th	ne below named inventor, I hereby declare that:
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	filed on
The	above-identified application was made or authorized to be made by me.
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LEGAL N	NAME OF INVE	NTOR			
Inventor:	Shuai Hu	••••••••••••••••••••••••••••••	Date:	Sept. 20. 2019	
Signature	of Inventor:	Shua	: MM	#*	

PATENT REEL: 052956 FRAME: 0832

RECORDED: 06/16/2020